
**200V 300W 45MHz**

# RF POWER MOSFETS

## N-CHANNEL ENHANCEMENT MODE

The ARF466FL is a rugged high voltage RF power transistor designed for scientific, commercial, medical and industrial RF power amplifier applications up to 45 MHz. It has been optimized for both linear and high efficiency classes of operation.

- Specified 150 Volt, 40.68 MHz Characteristics:
  - Output Power = 300 Watts.
  - Gain = 16dB (Class AB)
  - Efficiency = 75% (Class C)
- Low Cost Flangeless RF Package.
- Low Vth thermal coefficient.
- Low Thermal Resistance.
- Optimized SOA for Superior Ruggedness.

### Maximum Ratings

 All Ratings:  $T_c = 25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter	Ratings	Unit
$V_{DSS}$	Drain-Source Voltage	1000	V
$V_{DGO}$	Drain-Gate Voltage	1000	
$I_D$	Continuous Drain Current @ $T_c = 25^\circ\text{C}$	13	A
$V_{GS}$	Gate-Source Voltage	$\pm 30$	V
$P_D$	Total Power Dissipation @ $T_c = 25^\circ\text{C}$	1153	W
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	-55 to 175	$^\circ\text{C}$
$T_L$	Lead Temperature: 0.063" from Case for 10 Sec.	300	

### Static Electrical Characteristics

Symbol	Parameter	Min	Typ	Max	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage ( $V_{GS} = 0V, I_D = 250 \mu\text{A}$ )	1000			V
$R_{DS(ON)}$	Drain-Source On-State Resistance <sup>1</sup> ( $V_{GS} = 10V, I_D = 6.5A$ )			1.0	ohms
$I_{DSS}$	Zero Gate Voltage Drain Current ( $V_{DS} = 1000V, V_{GS} = 0V$ )			25	$\mu\text{A}$
	Zero Gate Voltage Drain Current ( $V_{DS} = 800V, V_{GS} = 0V, T_c = 125^\circ\text{C}$ )			250	
$I_{GSS}$	Gate-Source Leakage Current ( $V_{DS} = \pm 30V, V_{GS} = 0V$ )			$\pm 100$	nA
$g_{fs}$	Forward Transconductance ( $V_{DS} = 25V, I_D = 6.5A$ )	3.3	7	9	mhos
$V_{GS(TH)}$	Gate Threshold Voltage ( $V_{DS} = V_{GS}, I_D = 1mA$ )	2		4	Volts

### Thermal Characteristics

Symbol	Parameter	Min	Typ	Max	Unit
$R_{\theta JC}$	Junction to Case			0.13	$^\circ\text{C/W}$
$R_{\theta JHS}$	Junction to Sink (High Efficiency Thermal Joint Compound and Planar Heat Sink Surface.)			0.27	

 **CAUTION:** These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

## DYNAMIC CHARACTERISTICS

ARF466FL(G)

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
$C_{iss}$	Input Capacitance	$V_{GS} = 0V$ $V_{DS} = 150V$ $f = 1\text{ MHz}$		2000		pF
$C_{oss}$	Output Capacitance			165		
$C_{rss}$	Reverse Transfer Capacitance			75		
$t_{d(on)}$	Turn-on Delay Time	$V_{GS} = 15V$ $V_{DD} = 500V$ $I_D = 13A @ 25^\circ C$ $R_G = 1.6W$		12		ns
$t_r$	Rise Time			10		
$t_{d(off)}$	Turn-off Delay Time			43		
$t_f$	Fall Time			10		

## FUNCTIONAL CHARACTERISTICS

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
$G_{PS}$	Common Source Amplifier Power Gain	$f = 40.68\text{ MHz}$	14	16		dB
$h$	Drain Efficiency	$V_{GS} = 2.5V$ $V_{DD} = 150V$	70	75		%
$y$	Electrical Ruggedness VSWR 10:1	$P_{out} = 300W$	No Degradation in Output Power			

① Pulse Test: Pulse width < 380μS, Duty Cycle < 2%

Microsemi reserves the right to change, without notice, the specifications and information contained herein.

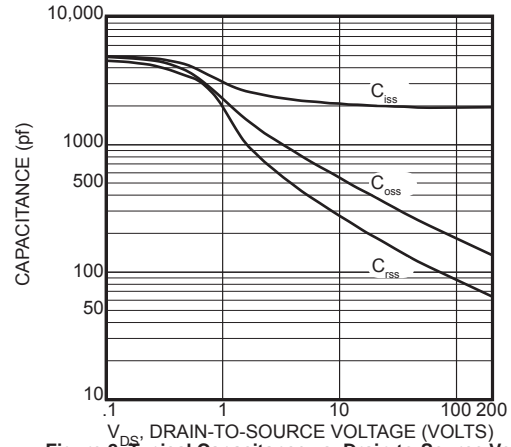


Figure 2, Typical Capacitance vs. Drain-to-Source Voltage

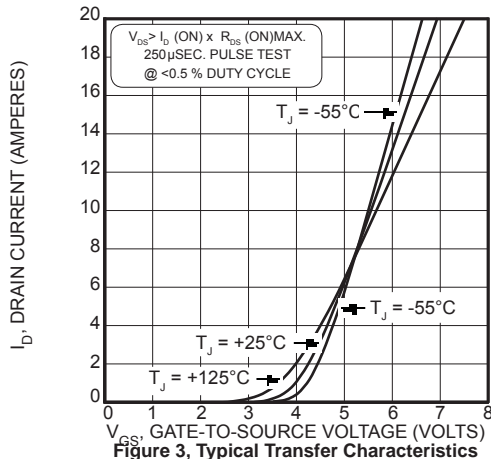


Figure 3, Typical Transfer Characteristics

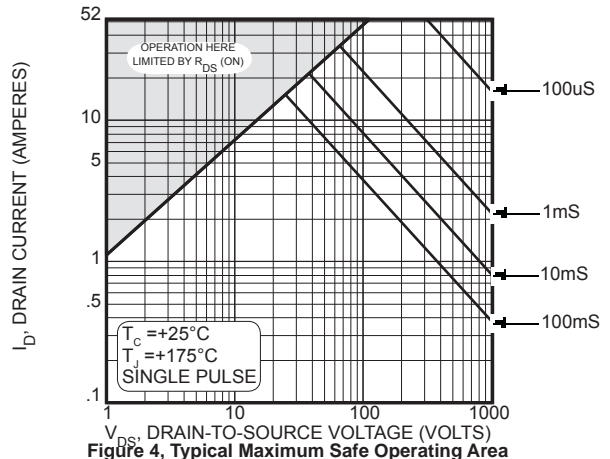


Figure 4, Typical Maximum Safe Operating Area

**TYPICAL PERFORMANCE CURVES**

ARF466FL(G)

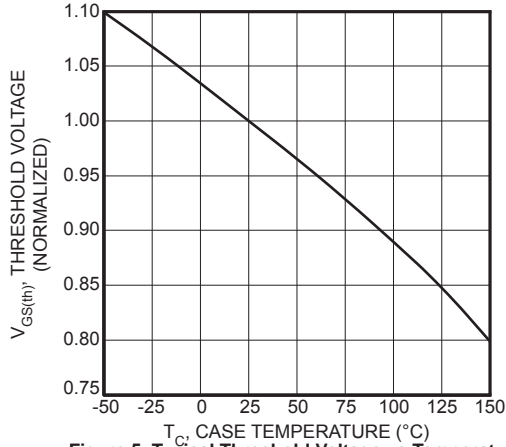


Figure 5, Typical Threshold Voltage vs Temperature

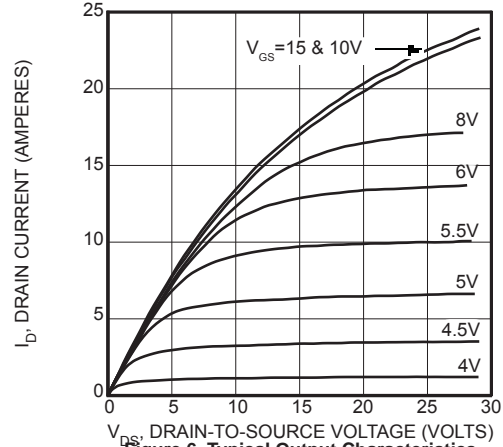


Figure 6, Typical Output Characteristics

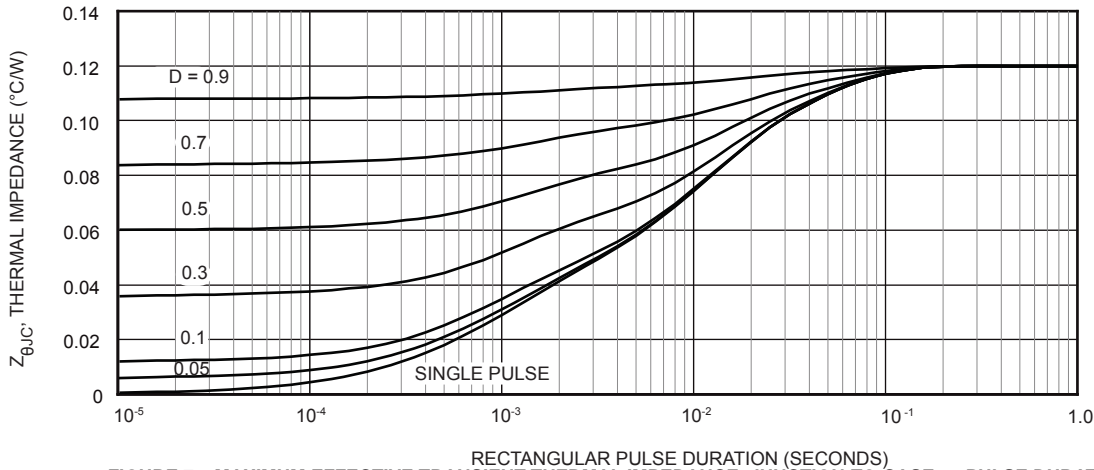


FIGURE 7a, MAXIMUM EFFECTIVE TRANSIENT THERMAL IMPEDANCE, JUNCTION-TO-CASE vs PULSE DURATION

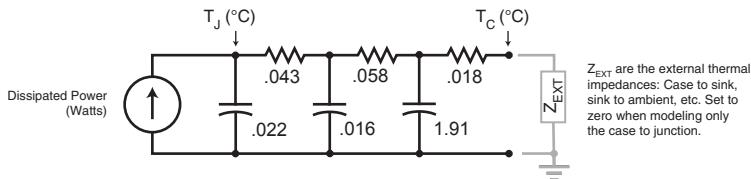


Figure 7b, TRANSIENT THERMAL IMPEDANCE MODEL

Table 1 - Typical Class AB Large Signal Input - Output Impedance

Freq. (MHz)	Z <sub>IN</sub> (Ω)	Z <sub>OL</sub> (Ω)
2.0	18 - j 11	30 - j 1.7
13.5	1.3 - j 5	25.7 - j 9.8
27.1	.40 - j 2.6	18 - j 13.3
40.7	.20 - j 1.6	12 - j 12.6
65	.11 + j 0.6	6.2 - j 8.9

Z<sub>in</sub> - Gate shunted with 25Ω I<sub>DQ</sub> = 100mA  
 Z<sub>OL</sub> - Conjugate of optimum load for 300 W output at V<sub>dd</sub> = 150V